L Number	Hits	Search Text	DB	Time stamp
1	4756	optoelectronic and lens\$2	USPAT; US-PGPUB;	2004/04/28 12:14
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
3	2773	(solder near bump\$1) and ((metal\$8 near pattern) or	USPAT;	2004/04/28 12:16
		(bonding near pad\$1))	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
4	68	optoelectronic and lens\$2) and ((solder near bump\$1) and	USPAT:	2004/04/28 12:16
•	08	((metal\$8 near pattern) or (bonding near pad\$1)))	US-PGPUB:	2004/04/20 12:10
		((metalipo fical pattern) of (boliding fical padp ()))	EPO: JPO:	
			DERWENT:	
			IBM_TDB	